

Description

The SZ-E10EF48 is a 80 V, 45 A Schottky diode for automotive applications. The product achieves characteristics such as low leakage current and low forward voltage drop, thus providing a high-efficient rectification circuit. Its low thermal resistance package has excellent performance in heat dissipation.

Features

• V _{RM}	80 V
• I _{F(AV)}	45 A
• $V_F (I_F = 45 \text{ A})$	0.76 V (typ.)
• H•I _R (T _J = 150 °C)	50 mA (max.)
Avalanche Power	3 kW
- D. J. J. F. Dl. C. (D.	IIC (C1'()

- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0
- Agt Recommended for Aes • Suitable for High Reliability and Automotive Requirements
- Anode Heatsink Package

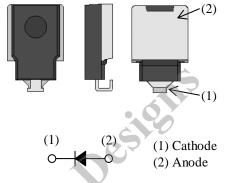
Applications

High speed switching applications such as:

- DC/DC Converter
- Adapter
- Secondary Rectifier Circuit

Package

SZ-E10



Not to scale

Absolute Maximum Ratings

Unless specifically noted, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit
Repetitive Peak Reverse Voltage	V_{RM}		80	V
Average Forward Current	I _{F(AV)}	$t/T \ge 1/4$, see Figure 3 and Figure 4.	45	A
Surge Forward Current	I_{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	300	A
Avalanche Power	P _A	$T_J = 25$ °C; $t_P = 10 \mu s$ (see Figure 1), 1 shot	3	kW
Junction Temperature	T_{J}		-55 to 150	°C
Storage Temperature	T_{STG}		-55 to 150	°C

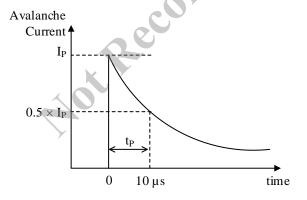
Electrical Characteristics

Unless specifically noted, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop	V_{F}	I _F = 45 A	_	0.76	0.82	V
Reverse Leakage Current	I_R	$V_R = V_{RM}$	_	_	50	μΑ
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 ^{\circ}C$	_	_	50	mA
Thermal Resistance ⁽¹⁾	R _{th(J-L)}	*	_	_	0.50	°C/W

Mechanical Characteristics

Parameter	Conditions	Min.	Тур.	Max.	Unit
Package Weight		_	2.6		g



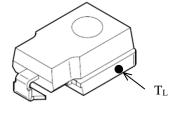
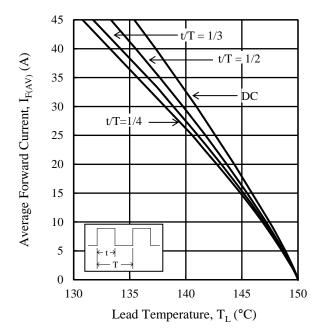


Figure 1. Definition of Pulse Width, t_P

Figure 2. Lead Temperature Measurement Point

⁽¹⁾ Refers to thermal resistance between junction and lead with infinite heatsink. Lead temperature is measured at anode lead (see Figure 2).

Derating Curves



 $Figure~3.~~I_{F(AV)}~vs.~T_L \label{eq:figure}$ $(T_J$ = 150 °C, V_R = 0 V, $R_{th(J\text{-}L)}$ = 0.50 °C/W)

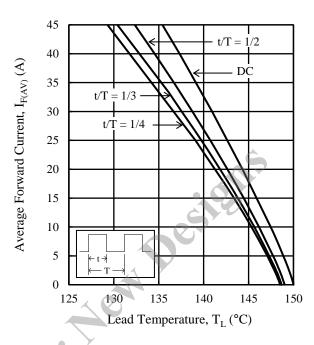


Figure 4. $I_{F(AV)}$ vs. T_L $(T_L = 150 \, ^{\circ}C, \, V_R = 80 \, V, \, R_{th(J-L)} = 0.50 \, ^{\circ}C/W)$

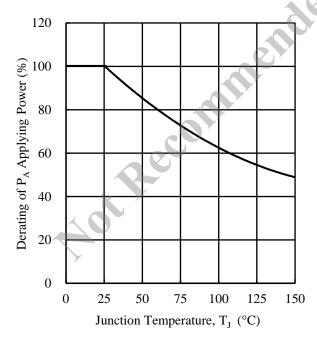


Figure 5. Derating of P_A Applying Power vs. T_J ($t_P = 10 \mu s$)

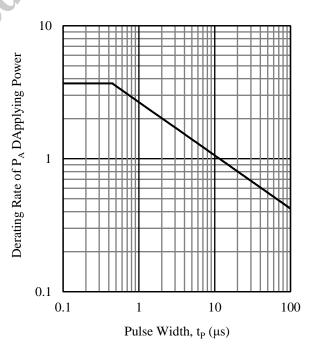


Figure 6. Derating Rate of P_A Applying Power vs. $t_P^{(2)}$ $(T_J = 25 \, ^{\circ}\text{C})$

⁽²⁾ See Figure 1.

Characteristic Curves

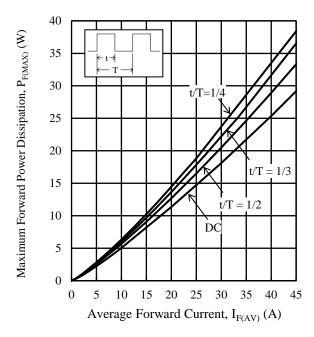


Figure 7. $P_{F(MAX)}$ vs. $I_{F(AV)}$ ($T_J = 150$ °C)

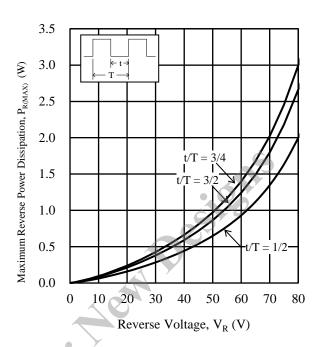


Figure 8. $P_{R(MAX)}$ vs. V_R ($T_J = 150$ °C)

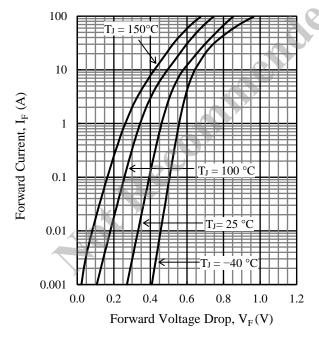


Figure 9. Typical Characteristics: I_F vs. V_F

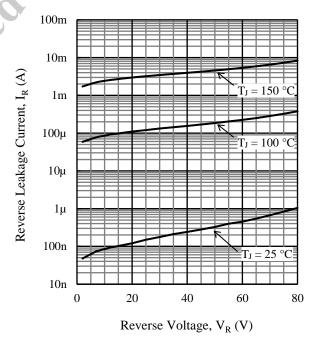


Figure 10. Typical Characteristics: I_R vs. V_R

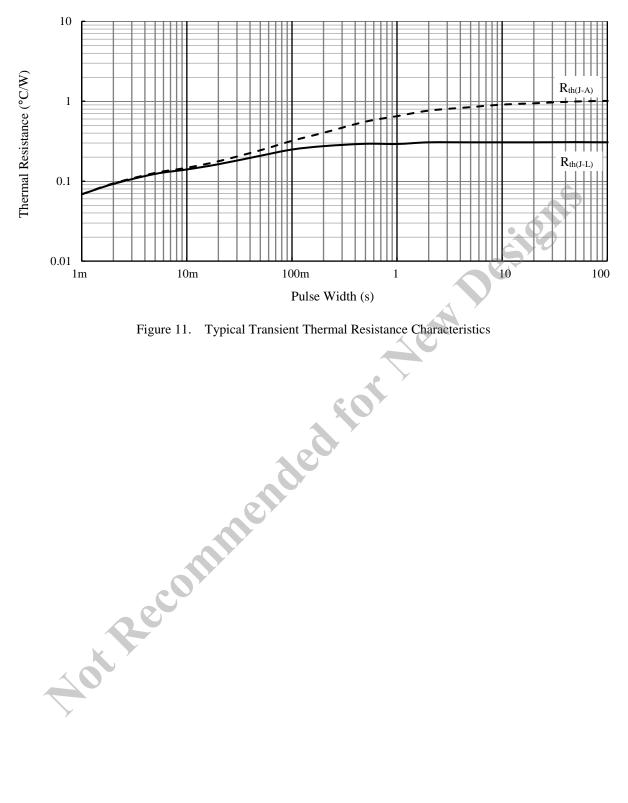
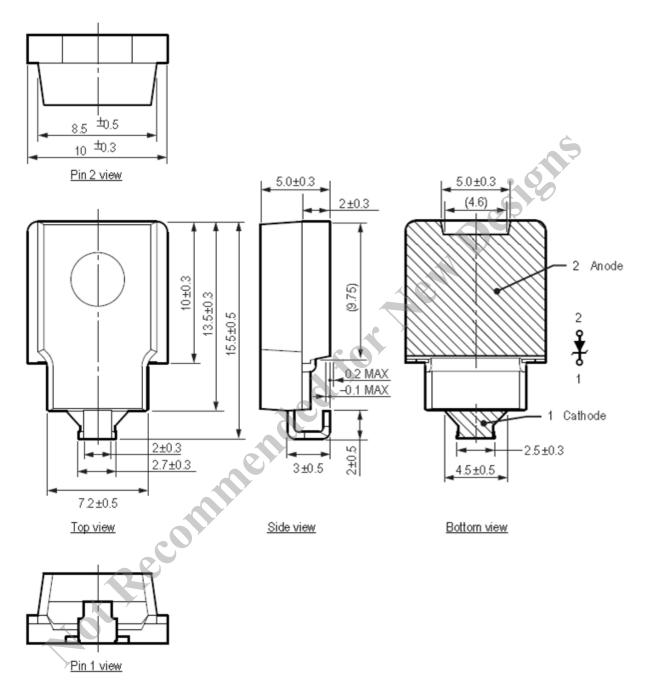


Figure 11. Typical Transient Thermal Resistance Characteristics

Physical Dimensions

• SZ-E10 Package



NOTES:

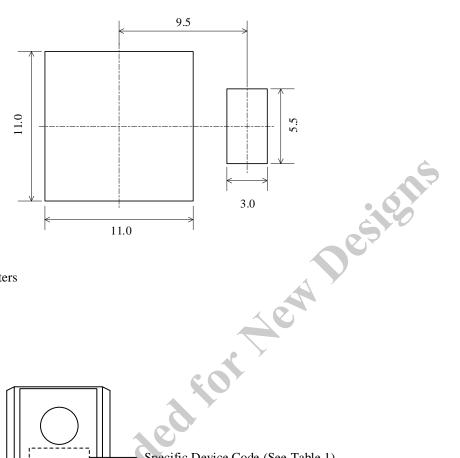
- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- MSL 3 (Moisture Sensitivity Level 3)
- When soldering the products, it is required to minimize the working time within the following limits: Reflow:

Preheat: 150 °C to 200 °C / 60 s to 120 s

Solder heating: 245 $^{\circ}\text{C}$ / 30s, 3 times (250 $^{\circ}\text{C}$ peak)

Soldering Iron: 350 °C / 3.5 s, 1 time

• SZ-E10 Land Pattern Example



NOTE:

- Dimensions in millimeters

Marking Diagram

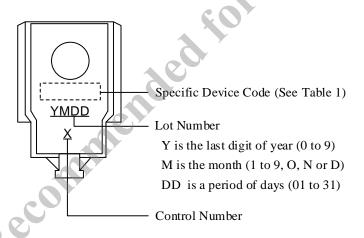


Table 1. Specific Device Code

Specific Device Code	Part Number		
EF48A	SZ-E10EF48		

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